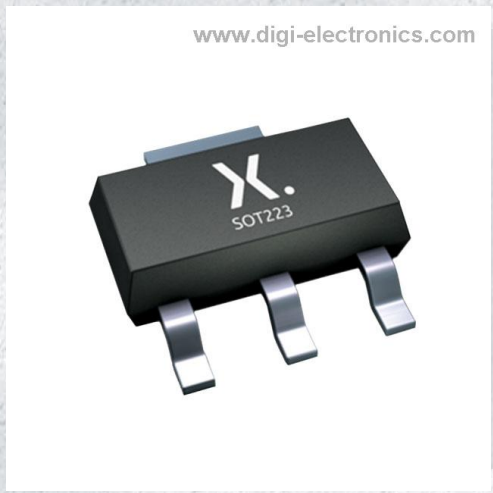
# PMT200EPEX Datasheet




https://www.DiGi-Electronics.com

| | |
|---|---|
| DiGi Electronics Part Number | PMT200EPEX-DG |
| Manufacturer | Nexperia USA Inc. |
| Manufacturer Product Number | PMT200EPEX |
| Description | MOSFET P-CH 70V 2.4A SOT223 |
| Detailed Description | P-Channel 70 V 2.4A (Ta) 800mW (Ta) Surface Mount SOT-223 |

Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com

## Purchase and inquiry

| Manufacturer Product Number: | Manufacturer: |
| --- | --- |
| PMT200EPEX | Nexperia USA Inc. |
| Series: | Product Status: |
| TrenchMOS™ | Active |
| FET Type: | Technology: |
| P-Channel | MOSFET (Metal Oxide) |
| Drain to Source Voltage (Vdss): | Current - Continuous Drain (Id) @ 25°C: |
| 70 V | 2.4A (Ta) |
| Drive Voltage (Max Rds On, Min Rds On): | Rds On (Max) @ Id, Vgs: |
| 4.5V, 10V | 167mOhm @ 2.4A, 10V |
| Vgs(th) (Max) @ Id: | Gate Charge (Qg) (Max) @ Vgs: |
| 3V @ 250µA | 15.9 nC @ 10 V |
| Vgs (Max): | Input Capacitance (Ciss) (Max) @ Vds: |
| ±20V | 822 pF @ 35 V |
| FET Feature: | Power Dissipation (Max): |
| - | 800mW (Ta) |
| Operating Temperature: | Mounting Type: |
| -55°C ~ 150°C (TJ) | Surface Mount |
| Supplier Device Package: | Package / Case: |
| SOT-223 | TO-261-4, TO-261AA |
| Base Product Number: | |
| PMT200 | |

## Environmental & Export classification

| RoHS Status: | Moisture Sensitivity Level (MSL): |
| --- | --- |
| ROHS3 Compliant | 1 (Unlimited) |
| REACH Status: | ECCN: |
| REACH Unaffected | EAR99 |
| HTSUS: | |
| 8541.21.0095 | |


# PMT200EPE

## 70 V, P-channel Trench MOSFET

**14 March 2018** **Product data sheet**

## 1. General description

P-channel enhancement mode Field-Effect Transistor (FET) in a medium power SOT223 (SC-73) Surface-Mounted Device (SMD) plastic package using Trench MOSFET technology.

## 2. Features and benefits

- Logic level compatible
- Very fast switching
- Trench MOSFET technology
- ElectroStatic Discharge (ESD) protection > 2 kV HBM

## 3. Applications

- Relay driver
- High-speed line driver
- High-side loadswitch
- Switching circuits

## 4. Quick reference data

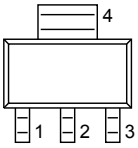
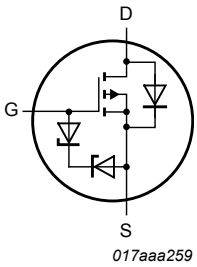
**Table 1. Quick reference data**

| Symbol | Parameter | Conditions | | Min | Typ | Max | Unit |
|---|---|---|---|---|---|---|---|
| $V_{DS}$ | drain-source voltage | $T_j$ = 25 °C | | - | - | -70 | V |
| $V_{GS}$ | gate-source voltage | | | -20 | - | 20 | V |
| $I_D$ | drain current | $V_{GS}$ = -10 V; $T_{amb}$ = 25 °C | [1] | - | - | -2.4 | A |
| **Static characteristics** | | | | | | | |
| $R_{DSon}$ | drain-source on-state resistance | $V_{GS}$ = -10 V; $I_D$ = -2.4 A; $T_j$ = 25 °C | | - | 130 | 167 | mΩ |

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated, mounting pad for drain 6 $cm^2$.

## 5. Pinning information

**Table 2. Pinning information**

| Pin | Symbol | Description | Simplified outline | Graphic symbol |
|---|---|---|---|---|
| 1 | G | gate |  SC-73 (SOT223) |  |
| 2 | D | drain | | |
| 3 | S | source | | |
| 4 | D | drain | | |

## 6. Ordering information

**Table 3. Ordering information**

| Type number | Package | | |
|---|---|---|---|
| | Name | Description | Version |
| PMT200EPE | SC-73 | plastic surface-mounted package with increased heatsink; 4 leads | SOT223 |

## 7. Marking

**Table 4. Marking codes**

| Type number | Marking code |
|---|---|
| PMT200EPE | T2EPE |

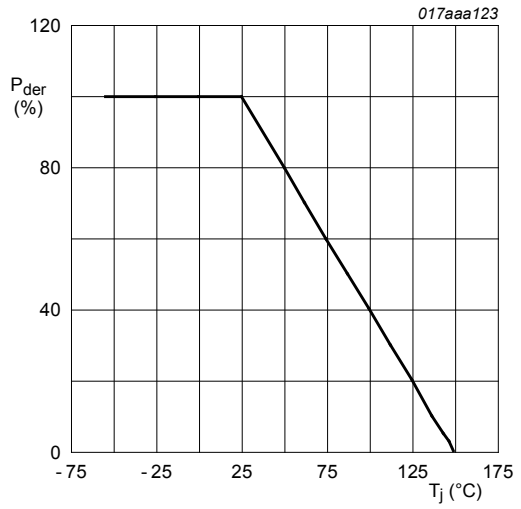
# 8. Limiting values

**Table 5. Limiting values**

*In accordance with the Absolute Maximum Rating System (IEC 60134).*

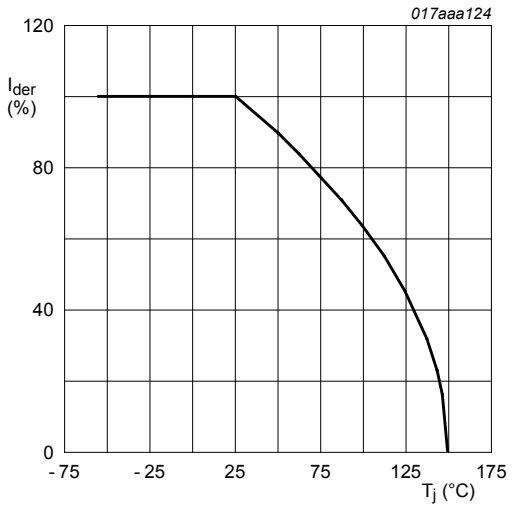
| Symbol | Parameter | Conditions | | Min | Max | Unit |
|---|---|---|---|---|---|---|
| $V_{DS}$ | drain-source voltage | $T_j$ = 25 °C | | - | -70 | V |
| $V_{GS}$ | gate-source voltage | | | -20 | 20 | V |
| $I_D$ | drain current | $V_{GS}$ = -10 V; $T_{amb}$ = 25 °C | [1] | - | -2.4 | A |
| | | $V_{GS}$ = -10 V; $T_{amb}$ = 100 °C | [1] | - | -1.5 | A |
| $I_{DM}$ | peak drain current | $T_{amb}$ = 25 °C; single pulse; $t_p \leq$ 10 µs | | - | -9.7 | A |
| $P_{tot}$ | total power dissipation | $T_{amb}$ = 25 °C | [2] | - | 800 | mW |
| | | | [1] | - | 1.75 | W |
| | | $T_{sp}$ = 25 °C | | - | 8.3 | W |
| $T_j$ | junction temperature | | | -55 | 150 | °C |
| $T_{amb}$ | ambient temperature | | | -55 | 150 | °C |
| $T_{stg}$ | storage temperature | | | -65 | 150 | °C |
| $E_{DS(AL)S}$ | non-repetitive drain-source avalanche energy | $T_{j(init)}$ = 25 °C; $I_D$ = -1.3 A; DUT in avalanche (unclamped) | | - | 19.5 | mJ |
| **Source-drain diode** | | | | | | |
| $I_S$ | source current | $T_{amb}$ = 25 °C | [1] | - | -1.8 | A |
| **ESD maximum rating** | | | | | | |
| $V_{ESD}$ | electrostatic discharge voltage | HBM | [3] | - | 2000 | V |

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated, mounting pad for drain 6 $cm^2$.
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
[3] Measured between all pins.



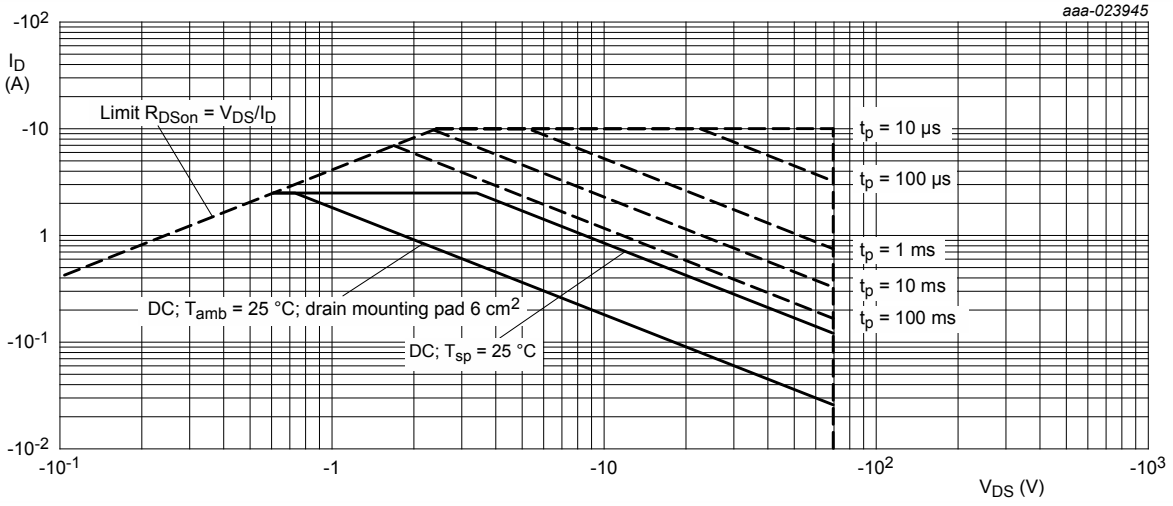

$$P_{der} = \frac{P_{tot}}{P_{tot(25°C)}} \times 100\ \%$$

**Fig. 1. Normalized total power dissipation as a function of junction temperature**




$$I_{der} = \frac{I_D}{I_{D(25°C)}} \times 100\ \%$$

**Fig. 2. Normalized continuous drain current as a function of junction temperature**




$I_{DM}$ = single pulse

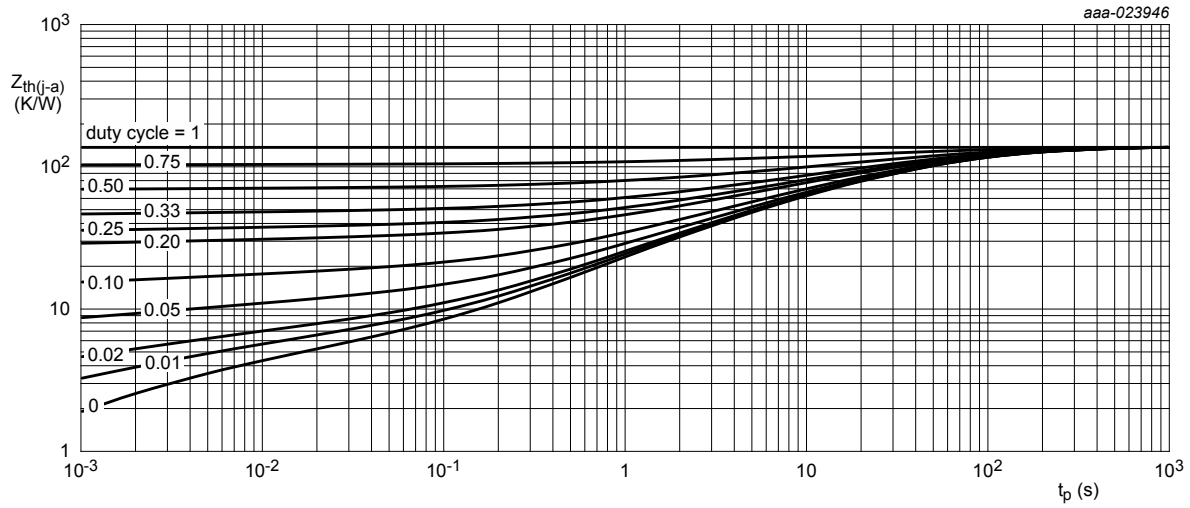
**Fig. 3. Safe operating area; junction to ambient; continuous and peak drain currents as a function of drain-source voltage**

# 9. Thermal characteristics

**Table 6. Thermal characteristics**

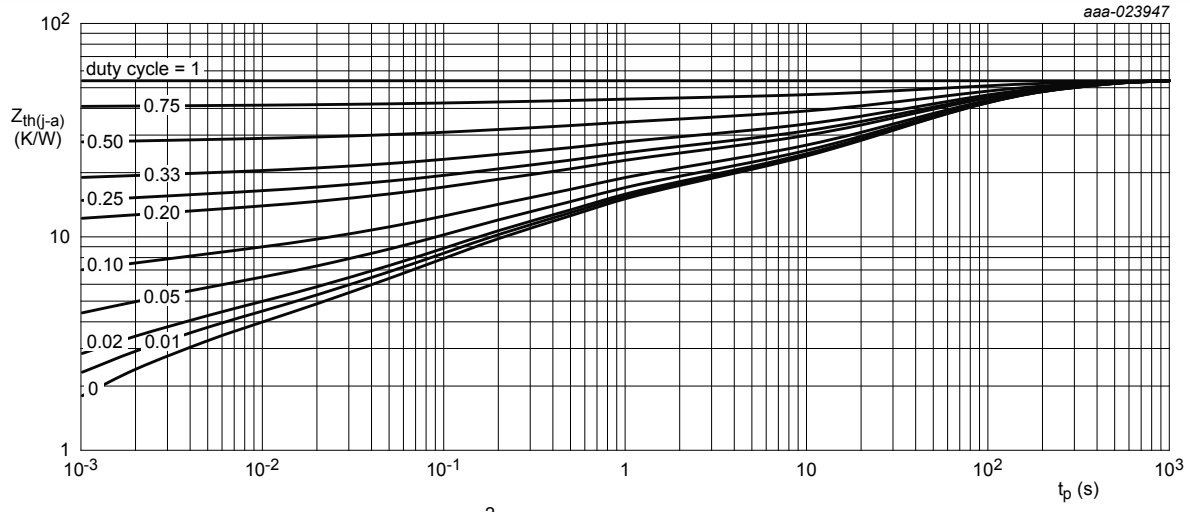
| Symbol | Parameter | Conditions | | Min | Typ | Max | Unit |
|---|---|---|---|---|---|---|---|
| $R_{th(j-a)}$ | thermal resistance from junction to ambient | in free air | [1] | - | 135 | 155 | K/W |
| | | | [2] | - | 54 | 70 | K/W |
| $R_{th(j-sp)}$ | thermal resistance from junction to solder point | | | - | 7 | 15 | K/W |

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for drain 6 $cm^2$.




FR4 PCB, standard footprint

**Fig. 4. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values**



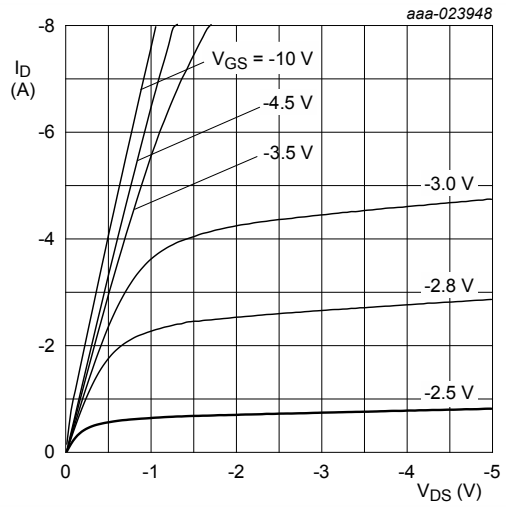

FR4 PCB, mounting pad for drain 6 $cm^2$

**Fig. 5. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values**

# 10. Characteristics

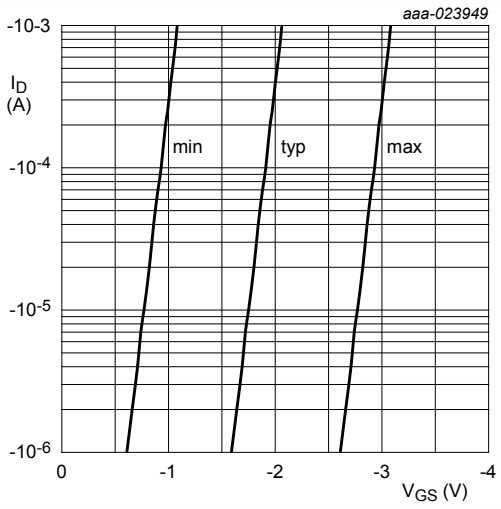
**Table 7. Characteristics**

| Symbol | Parameter | Conditions | | Min | Typ | Max | Unit |
|---|---|---|---|---|---|---|---|
| **Static characteristics** | | | | | | | |
| $V_{(BR)DSS}$ | drain-source breakdown voltage | $I_D$ = -250 µA; $V_{GS}$ = 0 V; $T_j$ = 25 °C | | -70 | - | - | V |
| $V_{GSth}$ | gate-source threshold voltage | $I_D$ = -250 µA; $V_{DS}$ = $V_{GS}$; $T_j$ = 25 °C | | -1 | -2 | -3 | V |
| $I_{DSS}$ | drain leakage current | $V_{DS}$ = -70 V; $V_{GS}$ = 0 V; $T_j$ = 25 °C | | - | - | -1 | µA |
| $I_{GSS}$ | gate leakage current | $V_{GS}$ = 20 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C | | - | - | 10 | µA |
| | | $V_{GS}$ = -20 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C | | - | - | -10 | µA |
| | | $V_{GS}$ = 10 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C | | - | - | 2 | µA |
| | | $V_{GS}$ = -10 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C | | - | - | -2 | µA |
| $R_{DSon}$ | drain-source on-state resistance | $V_{GS}$ = -10 V; $I_D$ = -2.4 A; $T_j$ = 25 °C | | - | 130 | 167 | mΩ |
| | | $V_{GS}$ = -10 V; $I_D$ = -2.4 A; $T_j$ = 150 °C | | - | 234 | 250 | mΩ |
| | | $V_{GS}$ = -4.5 V; $I_D$ = -2.1 A; $T_j$ = 25 °C | | - | 150 | 225 | mΩ |
| $g_{fs}$ | forward transconductance | $V_{DS}$ = -10 V; $I_D$ = -2.4 A; $T_j$ = 25 °C | | - | 13.5 | - | S |
| $R_G$ | gate resistance | f = 1 MHz | | - | 12 | - | Ω |
| **Dynamic characteristics** | | | | | | | |
| $Q_{G(tot)}$ | total gate charge | $V_{DS}$ = -35 V; $I_D$ = -2.4 A; $V_{GS}$ = -10 V; $T_j$ = 25 °C | | - | 10.6 | 15.9 | nC |
| $Q_{GS}$ | gate-source charge | | | - | 2.2 | - | nC |
| $Q_{GD}$ | gate-drain charge | | | - | 1.05 | - | nC |
| $C_{iss}$ | input capacitance | $V_{DS}$ = -35 V; f = 1 MHz; $V_{GS}$ = 0 V; $T_j$ = 25 °C | | - | 822 | - | pF |
| $C_{oss}$ | output capacitance | | | - | 47 | - | pF |
| $C_{rss}$ | reverse transfer capacitance | | | - | 31.5 | - | pF |
| $t_{d(on)}$ | turn-on delay time | $V_{DS}$ = -35 V; $I_D$ = -2.4 A; $V_{GS}$ = -10 V; $R_{G(ext)}$ = 6 Ω; $T_j$ = 25 °C | | - | 6 | - | ns |
| $t_r$ | rise time | | | - | 8 | - | ns |
| $t_{d(off)}$ | turn-off delay time | | | - | 42 | - | ns |
| $t_f$ | fall time | | | - | 20 | - | ns |
| **Source-drain diode** | | | | | | | |
| $V_{SD}$ | source-drain voltage | $I_S$ = -2.4 A; $V_{GS}$ = 0 V; $T_j$ = 25 °C | | - | -0.8 | -1.2 | V |



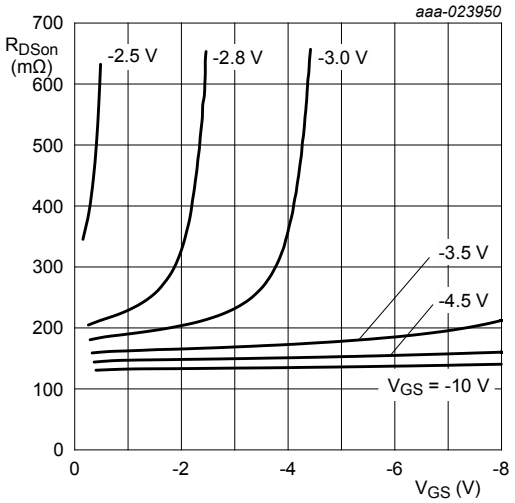

$T_j$ = 25 °C

**Fig. 6. Output characteristics: drain current as a function of drain-source voltage; typical values**



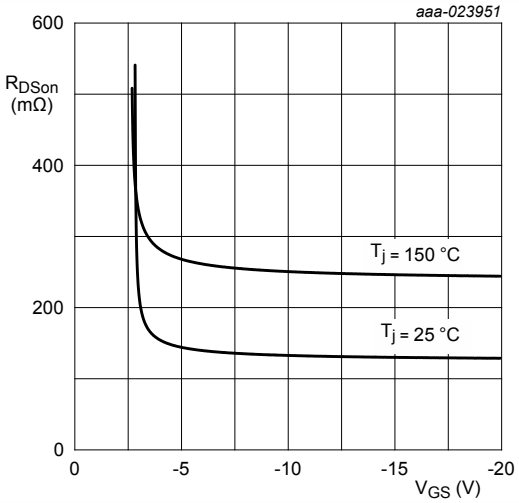

$V_{DS}$ = -5 V
$T_j$ = 25 °C

**Fig. 7. Sub-threshold drain current as a function of gate-source voltage**



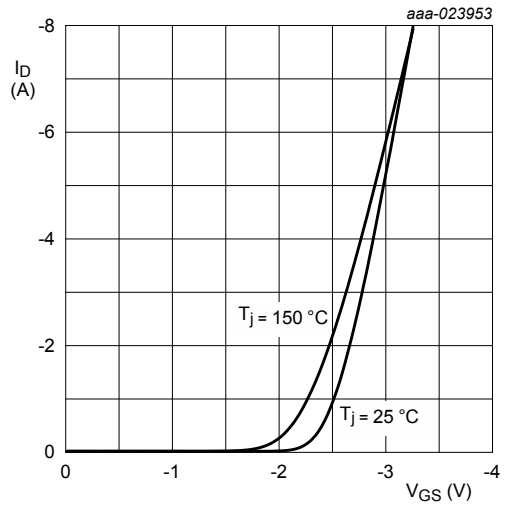

$T_j$ = 25 °C

**Fig. 8. Drain-source on-state resistance as a function of drain current; typical values**



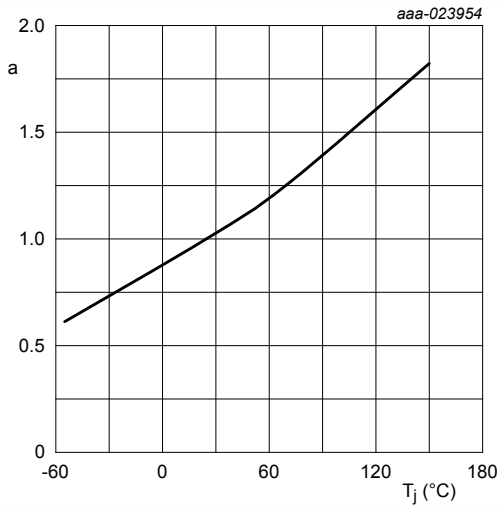

$I_D$ = -4 A

**Fig. 9. Drain-source on-state resistance as a function of gate-source voltage; typical values**



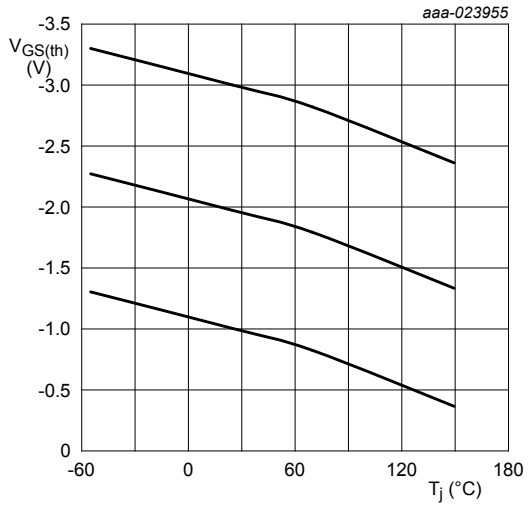

$V_{DS} > I_D \times R_{DSon}$

**Fig. 10. Transfer characteristics: drain current as a function of gate-source voltage; typical values**



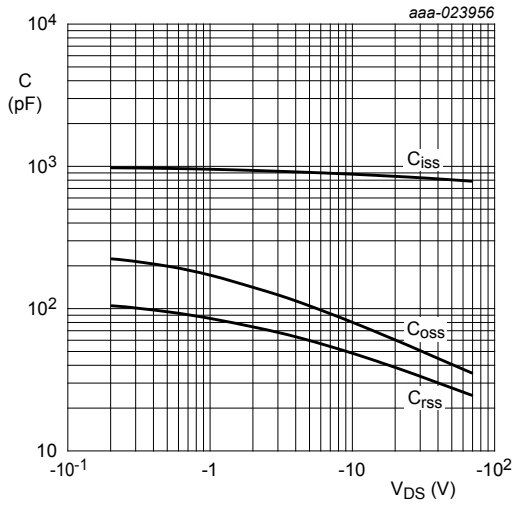

$$a = \frac{R_{DSon}}{R_{DSon(25\,°C)}}$$

**Fig. 11. Normalized drain-source on-state resistance as a function of junction temperature; typical values**



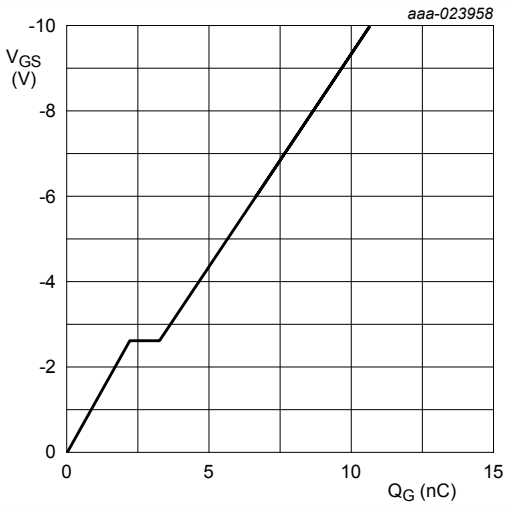

$I_D$ = - 250 µA; $V_{DS} = V_{GS}$

**Fig. 12. Gate-source threshold voltage as a function of junction temperature**




f = 1 MHz; $V_{GS}$ = 0 V

**Fig. 13. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values**




$V_{DS}$ = -35 V; $I_D$ = -2 A

**Fig. 14. Gate-source voltage as a function of gate charge; typical values**

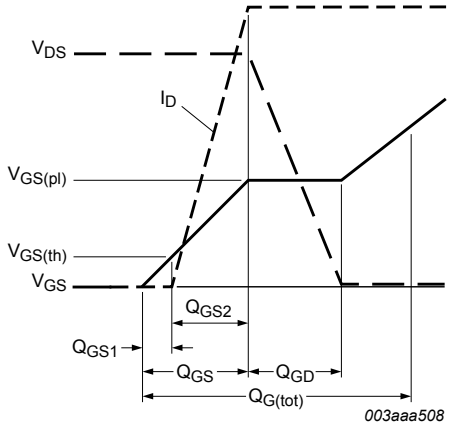
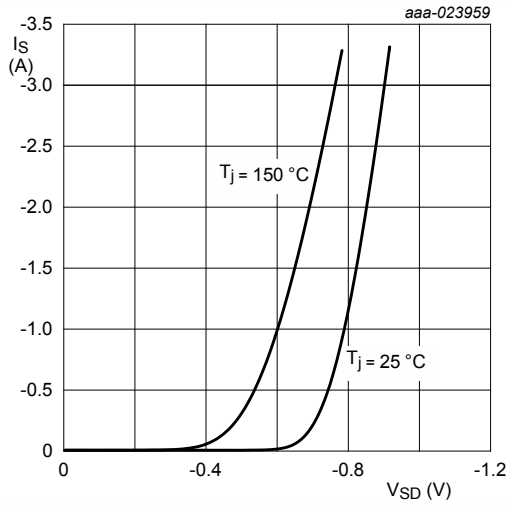



**Fig. 15. Gate charge waveform definitions**




$V_{GS}$ = 0 V

**Fig. 16. Source current as a function of source-drain voltage; typical values**

## 11. Test information

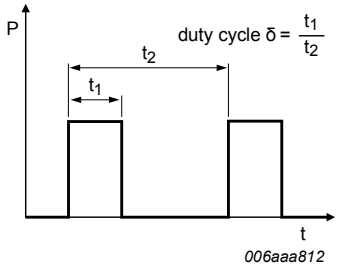
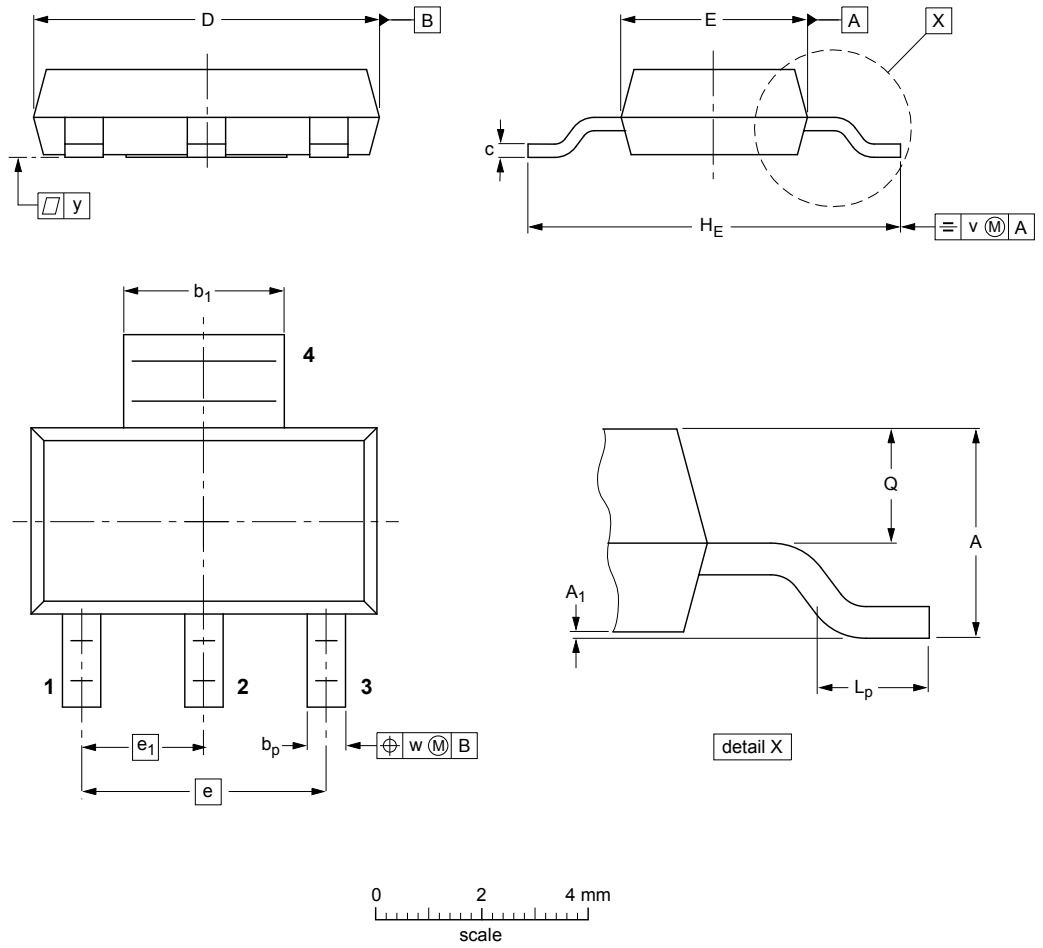



**Fig. 17. Duty cycle definition**

## 12. Package outline

**Plastic surface-mounted package with increased heatsink; 4 leads** **SOT223**




**DIMENSIONS (mm are the original dimensions)**

| UNIT | A | $A_1$ | $b_p$ | $b_1$ | c | D | E | e | $e_1$ | $H_E$ | $L_p$ | Q | v | w | y |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| mm | 1.8<br>1.5 | 0.10<br>0.01 | 0.80<br>0.60 | 3.1<br>2.9 | 0.32<br>0.22 | 6.7<br>6.3 | 3.7<br>3.3 | 4.6 | 2.3 | 7.3<br>6.7 | 1.1<br>0.7 | 0.95<br>0.85 | 0.2 | 0.1 | 0.1 |

| OUTLINE VERSION | REFERENCES | | | | EUROPEAN PROJECTION | ISSUE DATE |
|---|---|---|---|---|---|---|
| | IEC | JEDEC | JEITA | | | |
| SOT223 | | | SC-73 | | | ~~04-11-10~~<br>06-03-16 |

**Fig. 18. Package outline SC-73 (SOT223)**

## 13. Soldering

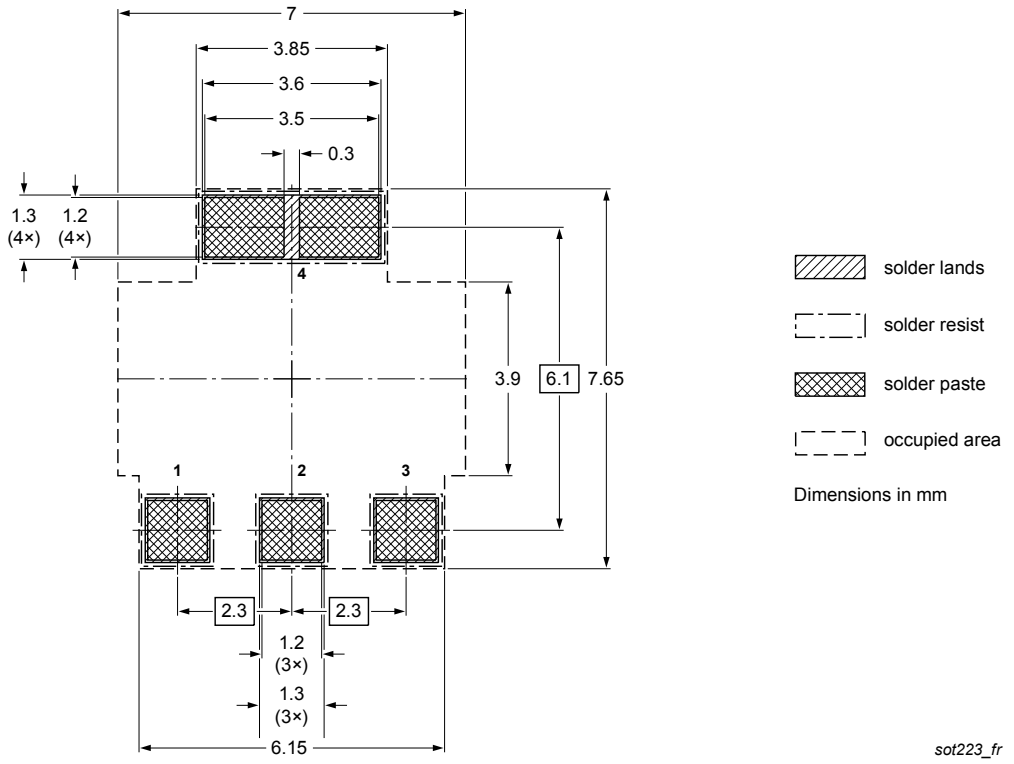



**Fig. 19. Reflow soldering footprint for SC-73 (SOT223)**

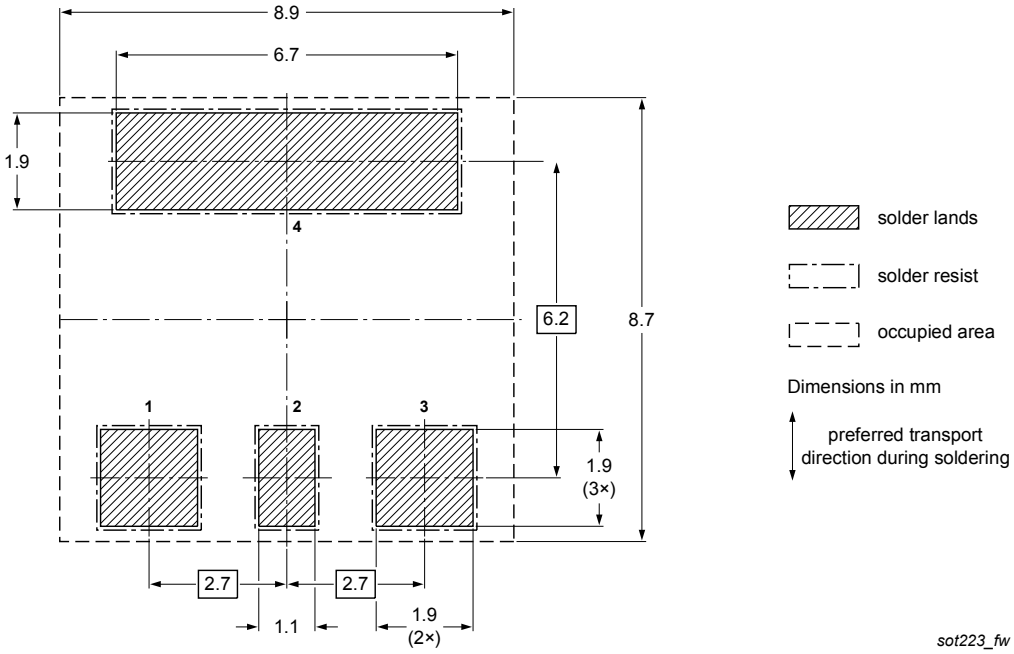



**Fig. 20. Wave soldering footprint for SC-73 (SOT223)**

# 14. Revision history

**Table 8. Revision history**

| Data sheet ID | Release date | Data sheet status | Change notice | Supersedes |
|---|---|---|---|---|
| PMT200EPE v.1 | 20180314 | Product data sheet | - | - |

# 15. Legal information

## Data sheet status

| Document status [1][2] | Product status [3] | Definition |
|---|---|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.
[2] The term 'short data sheet' is explained in section "Definitions".
[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nexperia.com.

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For more information, please visit: http://www.nexperia.com
For sales office addresses, please send an email to: salesaddresses@nexperia.com
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